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VS-FA38SA50LCP

Vishay Semiconductors

RoHS

COMPLIANT

Power MOSFET, 38 A

FEATURES

- Fully isolated package
- Easy to use and parallel
- Low on-resistance
- Dynamic dV/dt rating
- Fully avalanche rated
- Simple drive requirements
- Low drain to case capacitance
- Low internal inductance
- UL approved file E78996
- Designed for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third Generation Power MOSFETs from Vishay Semiconductors provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-227 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 500 W. The low thermal resistance of the SOT-227 contribute to its wide acceptance throughout the industry.

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Continuous drain current at V _{GS} 10 V	1-	T _C = 25 °C	38	
Continuous drain current at V _{GS} TO V	ID	T _C = 100 °C	24	A
Pulsed drain current	I _{DM} ⁽¹⁾		150	
Power dissipation	PD	T _C = 25 °C	500	W
Linear derating factor			4.0	W/°C
Gate to source voltage	V _{GS}		± 20	V
Single pulse avalanche energy	E _{AS} ⁽²⁾		580	mJ
Avalanche current	I _{AR} ⁽¹⁾		38	А
Repetitive avalanche energy	E _{AR} ⁽¹⁾		50	mJ
Peak diode recovery dV/dt	dV/dt ⁽³⁾		10	V/ns
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C
Insulation withstand voltage (AC-RMS)	V _{ISO}		2.5	kV
Mounting torque		M4 screw	1.3	Nm

Notes

⁽¹⁾ Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

 $^{(2)}$ Starting T_J = 25 °C, L = 0.80 mH, R_g = 25 $\Omega,$ I_AS = 38 A (see fig. 12)

 $^{(3)}$ $I_{SD} \leq 38$ Å, dl/dt ≤ 410 Å/µs, $V_{DD} \leq \breve{V}_{(BR)DSS}, \, T_J \leq 150~^\circ C$

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SOT-227

500 V

0.13 Ω

38 A

Modules - MOSFET

SOT-227

PRODUCT SUMMARY

V_{DSS}

R_{DS(on)}

 I_D

Туре

Package



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THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Junction and storage temperature range	T _J , T _{Stg}		- 55	-	150	°C
Junction to case	R _{thJC}		-	-	0.25	°C/W
Case to heatsink	R _{thCS}	Flat, greased surface	-	0.05	-	0/10
Weight			-	30	-	g
Mounting torque			-	-	1.3	Nm
Case style	SOT-227					

ELECTRICAL CHARACTERISTCS ($T_J = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER	SYMBOL TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS	
Drain to source breakdown voltage	V _{(BR)DSS}	$V_{(BR)DSS}$ $V_{GS} = 0 V, I_D = 1.0 mA$		-	-	V	
Breakdown voltage temperature coefficient	$\Delta V_{(BR)DSS} / \Delta T_J$	Reference to 25 °C, $I_D = 1 \text{ mA}$	-	0.66	-	V/°C	
Static drain to source on-resistance	R _{DS(on)} ⁽¹⁾	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 23 \text{ A}$	-	-	0.13	Ω	
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2.0	-	4.0	V	
Forward transconductance	g _{fs}	$V_{DS} = 25 \text{ V}, \text{ I}_{D} = 23 \text{ A}$	22	-	-	S	
Durain to course lookense current	1	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	50		
Drain to source leakage current	IDSS	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	500	μA	
Gate to source forward leakage		V _{GS} = 20 V	-	-	200		
Gate to source reverse leakage	- I _{GSS}	V _{GS} = - 20 V	-	-	- 200	nA	
Total gate charge	Qg	I _D = 38 A	-	280	420		
Gate to source charge	Q _{gs}	V _{DS} = 400 V		37	55	nC	
Gate to drain ("Miller") charge	Q _{gd}	V_{GS} = 10 V; see fig. 6 and 13 ⁽¹⁾	-	150	220	1	
Turn-on delay time	t _{d(on)}	V _{DD} = 250 V	-	42	-		
Rise time	t _r	I _D = 38 A	-	340	-		
Turn-off delay time	t _{d(off)}	$R_g = 10 \Omega (ιντερναλ)$	-	200	-	ns	
Fall time	t _f	$R_D = 8 \Omega$, see fig. 10 ⁽¹⁾	-	330	-		
Internal source inductance	L _S	Between lead, and center of die contact	-	5.0	-	nH	
Input capacitance	C _{iss}	V _{GS} = 0 V	-	6900	-		
Output capacitance	C _{oss}	$V_{DS} = 25 V$	-	1600	-	рF	
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz, see fig. 5	-	580	-	1	

Note

 $^{(1)}\,$ Pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

SOURCE-DRAIN RATINGS AND CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS MIN.		TYP.	MAX.	UNITS
Continuous source current (body diode)	IS	MOSFET symbol showing the integral reverse	-	-	38	Α
Pulsed source current (body diode)	I _{SM} ⁽¹⁾	p-n junction diode.	-	-	150	A
Diode forward voltage	V _{SD} ⁽²⁾	$T_J = 25 \ ^{\circ}C, \ I_S = 38 \ A, \ V_{GS} = 0 \ V$ -		-	1.3	V
Reverse recovery time	t _{rr}	T _J = 25 °C, I _F = 38 A; dl/dt = 100 A/µs ⁽²⁾	-	830	1300	ns
Reverse recovery charge	Q _{rr}	$I_{\rm J} = 25$ C, $I_{\rm F} = 38$ A, $di/dt = 100$ A/µs (=		μC		
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by $L_{S} + L_{D}$)				

Notes

⁽¹⁾ Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

⁽²⁾ Pulse width \leq 300 µs, duty cycle \leq 2 %

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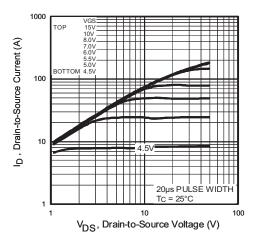


Fig. 1 - Typical Output Characteristics

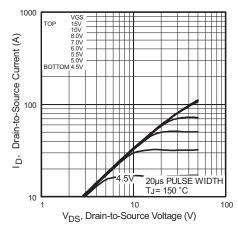
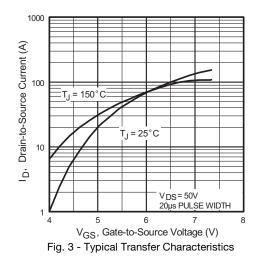
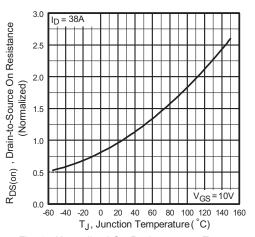


Fig. 2 - Typical Output Characteristics

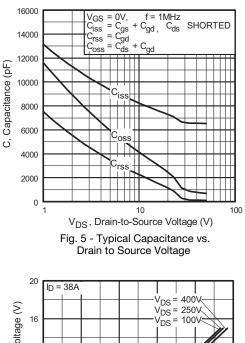


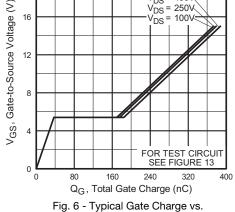


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Gate to Source Voltage

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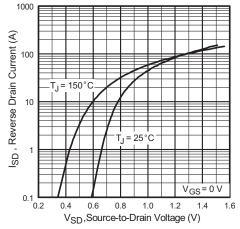


Fig. 7 - Typical Source Drain Diode Forward Voltage

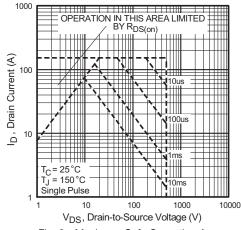


Fig. 8 - Maximum Safe Operating Area

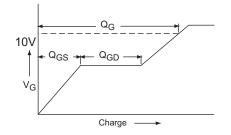


Fig. 9 - Basic Gate Charge Waveform

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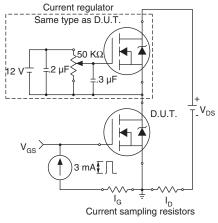


Fig. 10 - Gate Charge Test Circuit

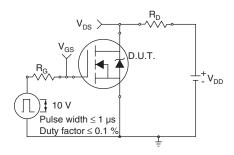


Fig. 11 - Switching Time Test Circuit

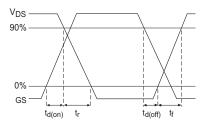
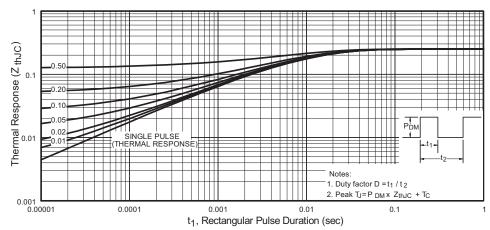


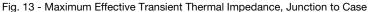
Fig. 12 - Switching Time Waveforms



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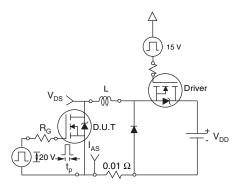
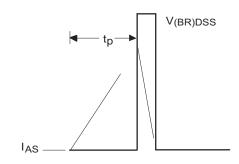
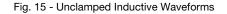


Fig. 14 - Unclamped Inductive Test Circuit





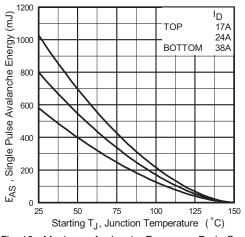


Fig. 16 - Maximum Avalanche Energy vs. Drain Current

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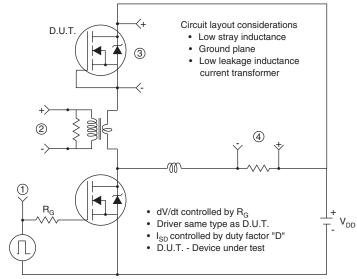
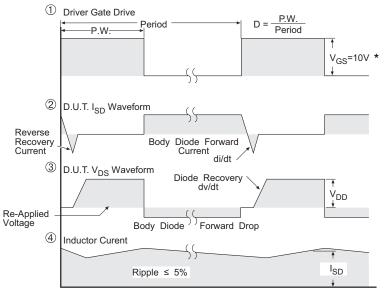


Fig. 17 - Peak Diode Recovery dV/dt Test Circuit



* V_{GS} = 5V for Logic Level Devices

Fig. 18 - For N-Channel Power MOSFETs



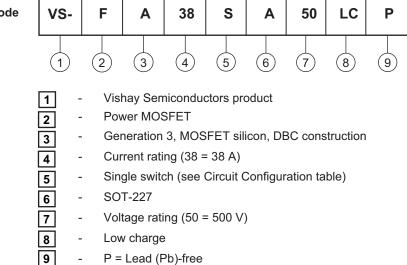
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ORDERING INFORMATION TABLE

Device code



CIRCUIT CONFIGURATION					
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING			
Single switch no diode	S	G (2) $G (2)$ $G (2$			

LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?95036				
Packaging information www.vishay.com/doc?95037				

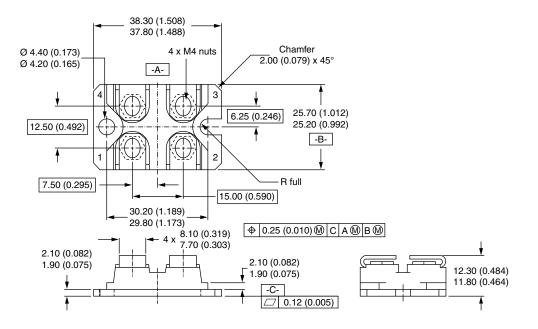


Outline Dimensions

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SOT-227

DIMENSIONS in millimeters (inches)



Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



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